

Pulsed Laser Single-Event Transient Testing of the MiniCircuits RAM-6+ MMIC Silicon Amplifier

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1. Introduction

The RAM-6+ is a Darlington configuration wideband amplifier offering high dynamic range, fabricated using silicon bipolar technology. The device was monitored for transients on the RF output and for any destructive events induced by exposing it to a pulsed laser beam at the Naval Research Laboratory (NRL) laser test facility.

2. Devices Tested

2.1 Mini-Circuits RAM-6+ Background

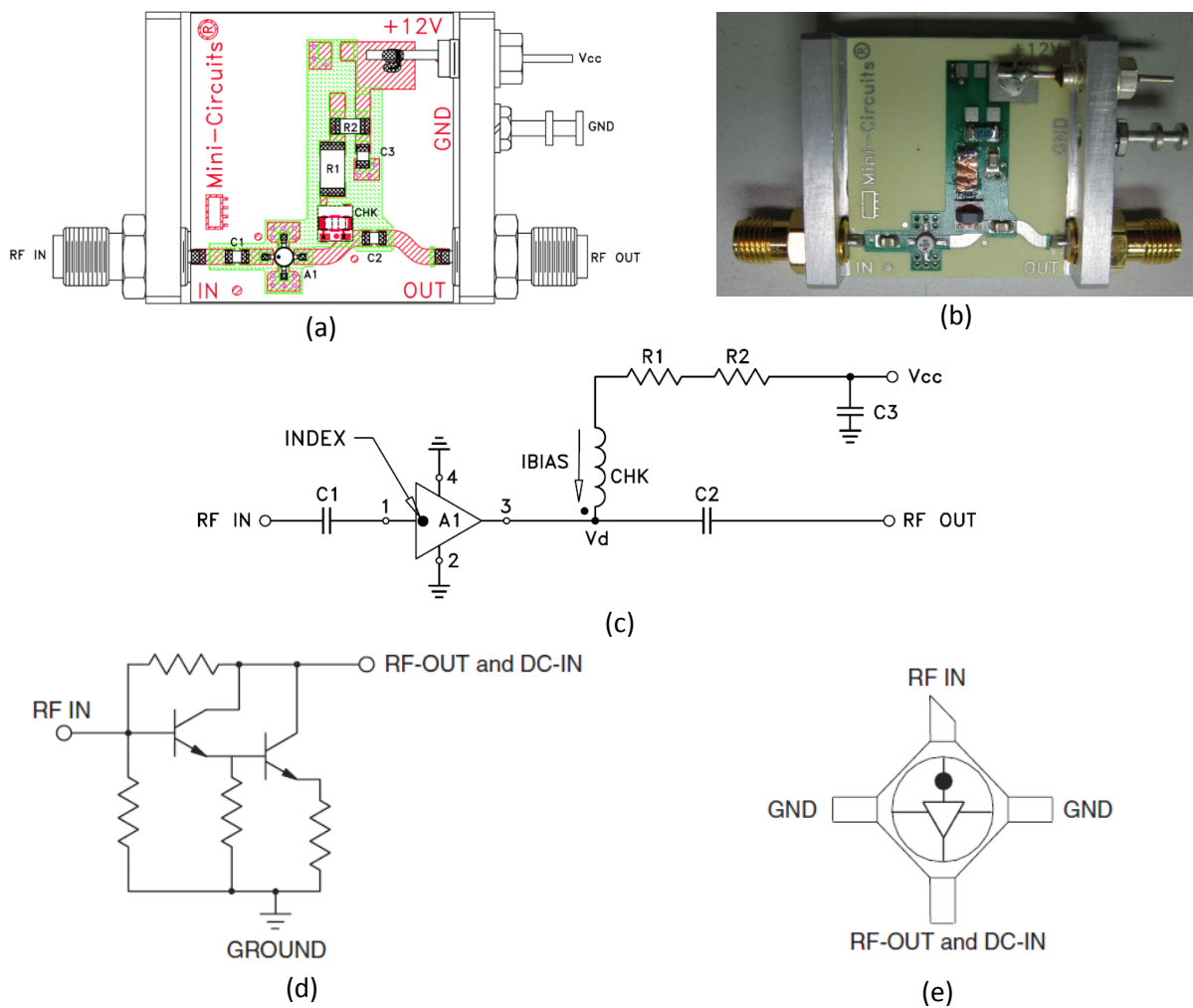


Figure 1: (a) Schematic drawing of the DUT evaluation card for the Mini-Circuits RAM-6+, (b) photograph of the evaluation board, (c) the accompanying circuit schematic, (d) the simplified equivalent circuit, and (e) the pin diagram. The passive component values are given in Table 1.

Table 1: Passive component values for the evaluation PCB shown in Figure 1

COMPONENT	VALUE
A1	RAM-6(+)
C1 [†]	2400 pF
C2 [†]	2400 pF
C3 (bypass)	0.1 μ F
R1	523 Ω , 0.75 W
R2	8.25 Ω , 0.25 W
CHK	Mini-Circuits TCCH-80+ (50 Ω RF choke)

[†] Capacitors, C1 & C2, should be free of resonance up to the highest frequency specified (2 GHz).

The configuration of the Mini-Circuits evaluation board is shown in Figure 1. DC bias was applied to the V_{CC} and GND pins. A SMA cable was connected to the RF OUT jack. The RF IN jack was either terminated (50 Ω) or connected to another SMA cable when RF IN was stimulated with a signal generator during transient testing. The component values of the evaluation board shown in Figure 1 are given in Table 1.

After removing the ceramic lid of the package, the die within was photographed at modest magnification to reveal the sensitive structures. These images are shown in Figure 2.

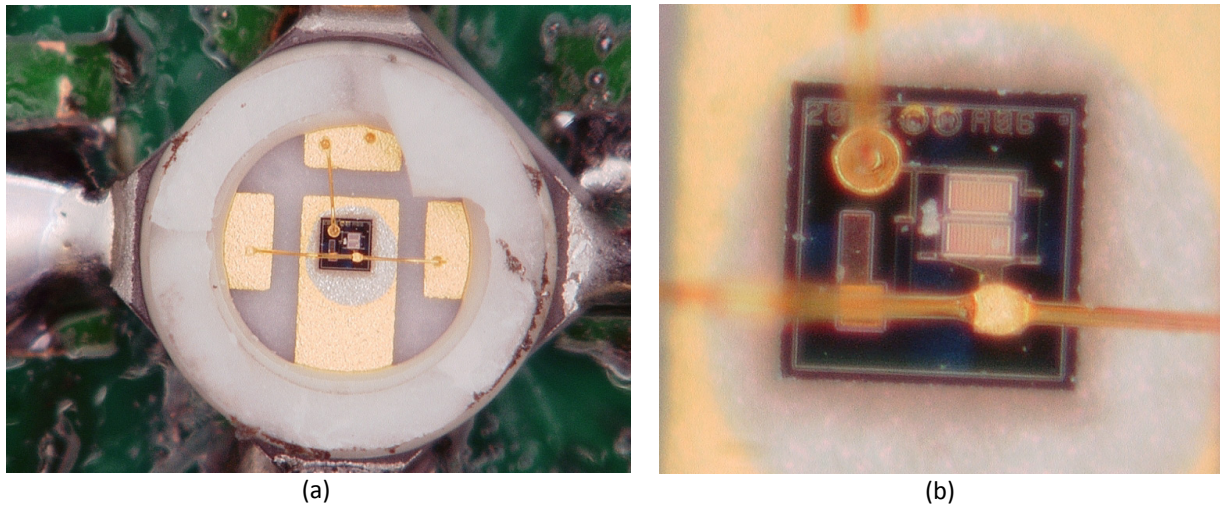


Figure 2: Die images of the RAM-6+ following de-lidding on an example part (*i.e.*, not used for testing). The sensitive bipolar transistor targets are visible in (b) as the eight “strip-like” structures next to the single left and right ball bonds. These structures produced transients when stimulated with the pulsed laser.

2.2 Device Under Test Information

Two devices were exposed to the pulsed laser beam at the NRL. The device lot date code was 0927. The DUT was packaged in a ceramic surface-mount AF190 package with tin/silver/nickel (RoHS) leads. The DUT was prepped for test by Timothy Irwin by first delidding the package and then soldering the DUT to the evaluation board.¹ This analog single-event transient (ASET) test is not application-specific and simply uses the factory-provided evaluation board shown in Figure 1. Table 2 lists the pertinent information about the DUT.

Table 2: RAM-3+ Sample Information

Part Number:	RAM-6+ (SMD: Non-DSCC Audited Part)
Manufacturer:	Mini-Circuits
Date Code:	0927 LDC is not marked on package
Additional Case Markings:	A06
Quantity Tested:	2
Part Function:	RF MMIC Amplifier
Part Technology:	Silicon Bipolar Monolithic Microwave Integrated Circuit
Package Style:	AF190 ceramic surface-mount

3. Test Setup

The test setup is shown in Figure 4 and consists of laptop running LabVIEW for instrument control and data capture, a Tektronix DSA72004B digital storage oscilloscope (20 GHz, 50 GS/s), an HP 83712B synthesized CW generator, and an Agilent N6702A MPS mainframe 4-channel power supply. The DUT evaluation board schematic diagram and photo are shown in Figure 1.

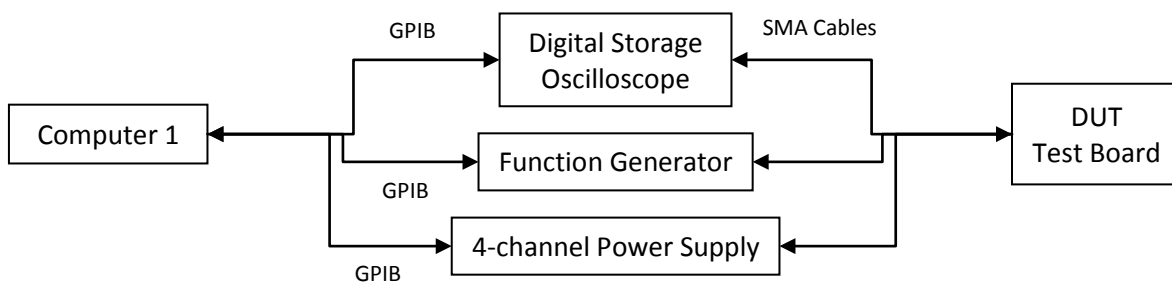


Figure 3: Block diagram for test setup of the RAM-6+.

¹ This occurred after the OEM RAM-6+ on the evaluation board was removed since it didn't belong to the flight lot.

4. Test Description

4.1 Irradiation Conditions

The tests were performed at the NRL using their single-photon absorption (SPA) setup. This system has been discussed in several refereed publications and will not be covered in detail [1-3]. The laser wavelength is 590 nm, has a pulse width of approximately 1 ps, and is operated at a 1 kHz repetition rate. A 100x microscope objective was used to focus the laser beam down to a full width half maximum (FWHM) Gaussian spot of approximately 1.2 μm . Throughout the test, the pulse intensity, as measured on a NRL oscilloscope, was varied using a waveplate polarizer and multiple neutral density filters with different optical densities for logarithmic coverage. Given these conditions, the resulting charge generation in the sensitive layers beneath the back end of line (BEOL) material stack is sufficient to conduct a conservative ASET analysis.

4.2 Test Parameters and Bias Conditions

The laser was focused onto the RAM-6+ die and scanned across the surface to produce transients on the RF output. This was done for different bias conditions, which are detailed in Table 3. This was not an application specific test; the only variables were the RF input conditions and the laser pulse energy. Transients were captured for all test conditions. In order to convert from laser pulse voltage to pulse energy, the conversion applied is 0.224 pJ/mV at an optical density of 1. The optical density of the neutral density filters used logarithmically modulates the laser pulse irradiance according to $(I/I_0) = 10^{-d}$, where I_0 is the un-attenuated irradiance and d is the optical density.

Table 3: Test Conditions Examined

Laser Pulse Voltage (mV) [†]	Neutral Density Filter Optical Density	RF Input Frequency (MHz)	Laser Pulse Energy (pJ)
0.018	2.0	DC	0.4
0.005	1.0	DC	1.1
0.015	1.0	DC	3.4

- The relative humidity throughout the test was constant at 45%.

- The ambient temperature was constant at 21° C.

† Note that laser pulse voltage is a relative measure of the laser pulse energy and depends upon an independent calibration to calculate the pulse energy.

5. Results

We scanned the laser across the RAM-6+ die for each of the laser pulse energy conditions specified in Table 3. The silicon bipolar transistors on the die were capable of producing transients at the RF output port of the evaluation board and were recorded by the oscilloscope. However, it appeared that the input and output transistors produced transients of different magnitudes and widths. These results are summarized in the plots shown below. One key feature to note is that the transient widths shown in Figure 4 and Figure 5 are measured at 10% of the transient peak.

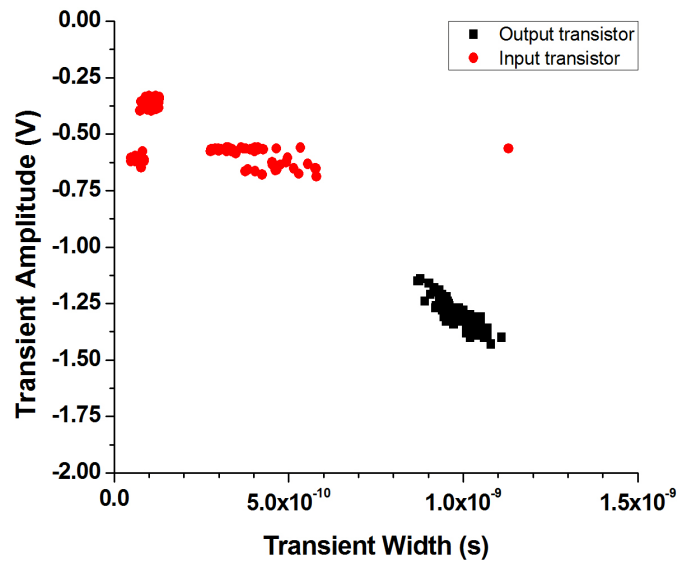


Figure 4: ASET amplitudes and widths for DC RF input conditions. It is clear that the input and output transistors have a large effect on the overall transient characteristics. All transients are negative. These transients were recorded at a laser pulse energy of 1.1 pJ.

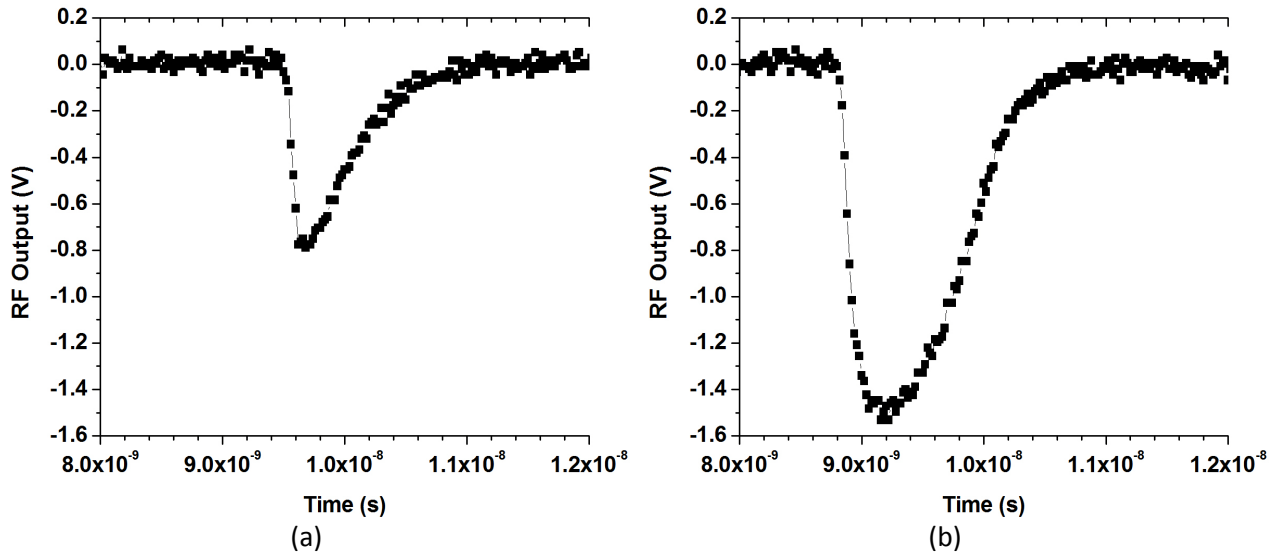


Figure 5: These figures show ASETs for DC RF input characteristics at pulse energies of 1.1 pJ. (a) shows an ASET on the input BJT while (b) shows an ASET on the output BJT. These results were consistent across laser pulse energies.

6. Conclusions and Recommendations

The Mini-Circuits RAM-6+ tested here showed transients less than 1.6 V in amplitude for DC RF input conditions up to a laser pulse energy of 1.1 pJ. The transients widths, measured at 10% of the peak voltage, ranged from 100 ps to 1.1 ns. Based on testing of similar MMIC amplifiers, if the RF input was stimulated with an AC small signal, the transient effects would only affect the output signal for a maximum of 1.1 ns based on the current data. If the laser pulse energy was increased, the transients might grow in amplitude and width, but usually saturate very quickly.

Silicon bipolar technologies generally suffer from large single-event cross sections due to large charge collection efficiencies and large sensitive volumes. The results shown here seem to indicate that the response saturated quickly with increasing laser pulse energy. We assume that these ASETs bound the heavy ion response of the device.

Based on the pulsed laser test results, the Mini-Circuits RAM-6+ is recommended for use in NASA/GSFC spaceflight applications, but may require transient mitigation (*i.e.*, filtering) techniques to reduce the effect of ion-generated transients.

7. References

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